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#15/B*

0010-1098-0

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF: :  
YASUAKI SEKI ET AL : EXAMINER: PATEL  
SERIAL NO.: 09/539,864 :  
FILED: MARCH 31, 2000 : GROUP ART UNIT: 2841  
FOR: INSULATING RESIN COMPOSITION  
FOR MULTILAYER PRINTED-  
WIRING BOARD

SUPPLEMENTAL REQUEST FOR RECONSIDERATION

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ASSISTANT COMMISSIONER FOR PATENTS  
WASHINGTON, D.C. 20231

SEP 20 2002

TECHNOLOGY CENTER 2800

SIR:

In further responsive to the Official Action dated November 7, 2001, Applicants submit herewith a clean copy of Claim 20 as amended in the Amendment filed on May 7, 2002.

IN THE CLAIMS

Please amend the claims as follows:

20. (Amended) The multilayer printed-wiring board of Claim 19, wherein said plasma-treated insulating layer has a surface roughness of 100 nm to 4,000 nm.

*31*

REMARKS

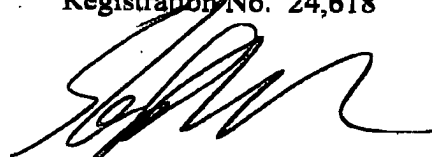
In the Amendment filed on May 7, 2002, Applicants inadvertently failed to present a clean copy of amended Claim 20. Applicants are correcting this oversight by filing herewith a clean copy of Claim 20 as amended in the Amendment filed on May 7, 2002.

Applicants again submit that the application is in condition for allowance, and early notification of such action is earnestly solicited.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,  
MAIER & NEUSTADT, P.C.

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